



SDW

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Takayuki KONDO

Group Art Unit: 2874

Application No.: 10/673,444

Examiner: P. PALMER

Filed: September 30, 2003

Docket No.: 116955

For: OPTICAL INTERCONNECTION CIRCUIT, MANUFACTURING METHOD
THEREOF, ELECTRO-OPTICAL DEVICE AND ELECTRONIC EQUIPMENT

REQUEST FOR RECONSIDERATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In reply to the June 22, 2006 Office Action, reconsideration of the Application is respectfully requested in light of the following remarks.

Claims 1 and 3-33 are pending in this Application. Applicant appreciates the Office Action's indication that claims 22-31 are allowed, and claims 4-14 contain allowable subject matter.

The Office Action rejects claims 1, 3, 15-21, 32 and 33 under 35 U.S.C. §103(a) over U.S. Patent No. 5,650,123 to Saini et al. (Saini). This rejection is respectfully traversed.

The Office Action acknowledges that Saini does not disclose a first element and a second element that are fixed on a substrate by an adhesive, but asserts that this feature is obvious over Saini's disclosure of embedding a detector 16 in substrate 12. However, Saini's "embedding" does not render obvious the use of an adhesive, as discussed below.